

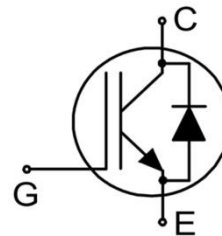
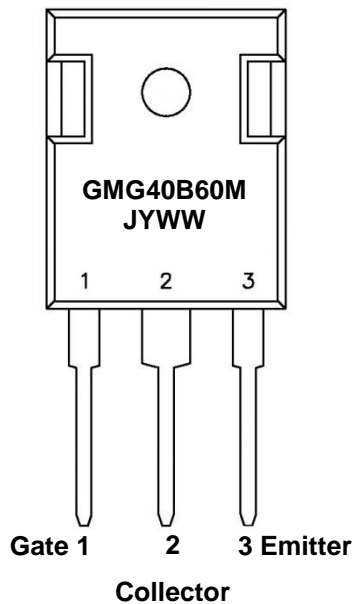
Features

- ◆ Trench Field Stop technology
- ◆ Fast Switching Characteristics
- ◆ Low Turnoff Voltage Spike
- ◆ Ultrafast Recovery Diodo embedded
- ◆ Low Forward Voltage
- ◆ Low Leakage Current

Applications

- ◆ Uninterruptable Power System, UPS
- ◆ General Purpose Frequency Conversion

Marking Information and Pin Assignment – TO-247 (Top View)



J: Assembly / Test Site Code
Y: Year
WW: Week

Order Information

Ordering Number	Package	Shipping
GMG40B60MTD3T	TO-247	50 Units/Tube. 40 Tubes/Box, 4 Boxes/Carton

Absolute Maximum Ratings (Note 1)

SYMBOL	PARAMETER		RATINGS	UNITS
V_{CES}	Collector to Emitter Voltage		600	V
I_C	Collector Current	$T_C = 25^\circ\text{C}$	80	A
		$T_C = 100^\circ\text{C}$	40	
I_{CP} (Note 2)	Collector Pulse Current		120	A
I_{RBSOA} (Note 2)	RBSOA Current $V_{CE} \leq 600\text{V}$, $T_J \leq 150^\circ\text{C}$, $t_p = 1\mu\text{s}$		120	A
I_F	Diode Forward Current	$T_C = 25^\circ\text{C}$	80	A
		$T_C = 100^\circ\text{C}$	40	
I_{CF} (Note 2)	Diode Pulse Current		150	A
t_{SC}	Short Circuit Withstand Duration, $V_{GE}=15\text{V}$, $V_{CC}=400\text{V}$, $T_J \leq 150^\circ\text{C}$		10	μs
V_{GE}	Gate-Emmitter Voltage		± 20	V
P_{TOT}	Power dissipation,	$T_C = 25^\circ\text{C}$	280	W
		$T_C = 100^\circ\text{C}$	110	
T_J	Maximum IGBT Junction Temperature		-55 ~ 150	$^\circ\text{C}$
T_{stg}	Storage Temperature Range		-55 ~ 150	$^\circ\text{C}$

Note 1 Compliance to JESD-022

Note 2 Simulated Results

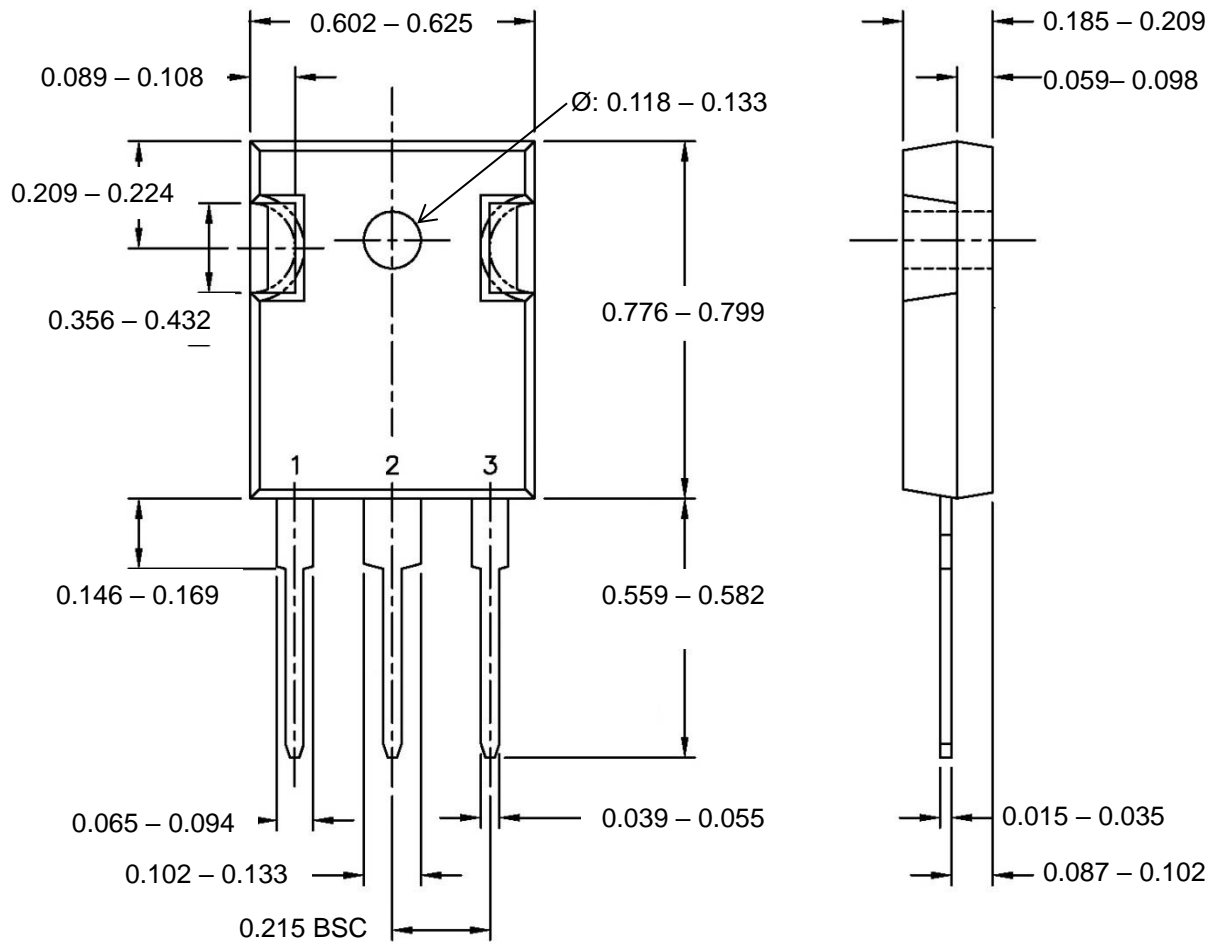
Note 3 Short Circuit < 1000 times, Short Circuit Interval: > 1s

Electrical Characteristics (T_J = 25°C, unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit	
Statistic Characteristic							
Collector to Emitter Breakdown Voltage	V _{BR,CE}	V _{GE} =0V, I _C =250μA	600			V	
Collector to Emitter Saturation Voltage	V _{CE,SAT}	V _{GE} =15V, I _C =40A		1.8	2.3	V	
		V _{GE} =15V, I _C =40A, T _J = 150°C		2.3			
Diode Forward Voltage	V _F	V _{GE} =0V I _F =40A		1.5		V	
Gate Threshold Voltage	V _{GE}	I _C =1mA, V _{CE} =V _{GE}	5.0	5.9	7.0	V	
Collector Leakage Current	I _{CES}	V _{CE} =600V, V _{GE} =0V			0.1	mA	
		V _{CE} =600V, V _{GE} =0V, T _J =150°C			4		
Gate Leakage Current	I _{GES}	V _{GE} =20V, V _{CE} =0V			250	nA	
Transconductance	g _{FS}	V _{CE} =20V, I _C =40A		20		S	
Dynamic Characteristic							
Input Capacitance	C _{ISS}	V _{CE} =30V, V _{GE} =0V, f=1MHz		3155		pF	
Output Capacitance	C _{OSS}				175		pF
Reverse Transfer Capacitance	C _{RES}				81.5		pF
Gate Charge	Q _G	V _{CC} =600V, I _C =40A, V _{GE} =15V		165		nC	
IGBT Switching Characteristic							
Turn ON Delay time	t _{D(ON)}	V _{CC} =400V, I _C =40A, V _{GE} =0/15V, R _G =10Ω, inductive load		36		ns	
Rise Time	t _r			52			
Turn OFF delay time	t _{D(OFF)}			210			
Fall Time	t _f			62			
Turn ON Energy Loss	E _{ON}				2.5		mJ
Turn OFF Energy Loss	E _{OFF}			0.8			
Switching Energy Loss	E _{ts}			3.3			
Turn ON Delay time	t _{D(ON)}	V _{CC} =400V, I _C =40A, V _{GE} =0/15V, R _G =10Ω, , T _J = 150°C inductive load		72		ns	
Rise Time	t _r			71			
Turn OFF delay time	t _{D(OFF)}			300			
Fall Time	t _f			120			
Turn ON Energy Loss	E _{ON}				2.8		mJ
Turn OFF Energy Loss	E _{OFF}				1.3		
Switching Energy Loss	E _{ts}				4.1		
Diode Switching Characteristic							
Reverse Recovery Time	t _{rr}	V _R =400V, I _F =40A, dI _F /dt = 200A/μs		75		ns	
Reverse Recovery Charge	Q _{rr}				0.22		μC
Reverse Recovery Peak Current	I _{rrm}				6.5		A

Package Dimension – TO247

Unit: Inches





GMG40B60M

40A, 600V, Fast Switching IGBT

Ordering Number

GM **G** **40B60M** **TD3** **I**

APM Gamma Micro	Product Category	Short Description	Package Type	Shipping Type
	Discrete IGBT	40: $I_C = 40A$ 120: $V_{CE} = 600V$	TD3: 3L TO247	T: Tube

Note:

Green products:

- ♦ Halogen free(Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight)